

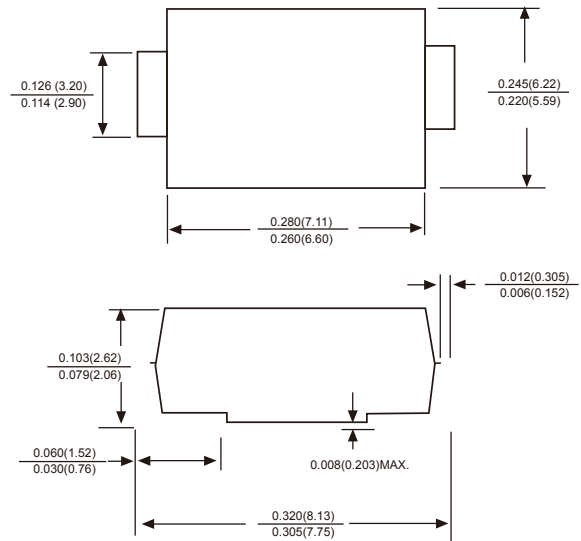
FEATURES

The plastic package carries Underwriters Laboratory
 Flammability Classification 94V-0
 For surface mounted applications
 Super fast switching for high efficiency
 Low reverse leakage
 Built-in strain relief, ideal for automated placement
 High forward surge current capability
 High temperature soldering guaranteed:
 260 C/10 seconds at terminals
 Glass passivated chip junction

MECHANICAL DATA

Case: JEDEC DO-214AB molded plastic body over passivated chip
Terminals: Solder plated, solderable per MIL-STD-750,
 Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.007 ounce, 0.25grams

SMC / DO-214AB



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 C ambient temperature unless otherwise specified.
 Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

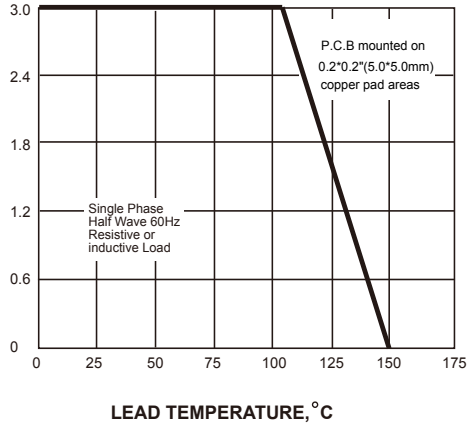
	SYMBOLS	ES3K	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	800	V
Maximum RMS voltage	V_{RMS}	560	V
Maximum DC blocking voltage	V_{DC}	800	V
Maximum average forward rectified current at $T_L=75^\circ\text{C}$	$I_{(AV)}$	3.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	100.0	A
Maximum instantaneous forward voltage at 2.0A	V_F	2.2	V
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$	I_R	5.0 50.0	μA
Maximum reverse recovery time (NOTE 1)	t_{rr}	35	ns
Typical junction capacitance (NOTE 2)	C_J	45.0	pF
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$	55.0	$^\circ\text{C/W}$
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Note: 1.Reverse recovery condition $I_F=0.5\text{A}, I_R=1.0\text{A}, I_{rr}=0.25\text{A}$
 2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.
 3.P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas



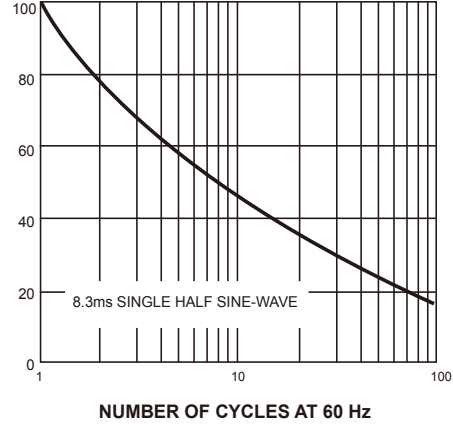
AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



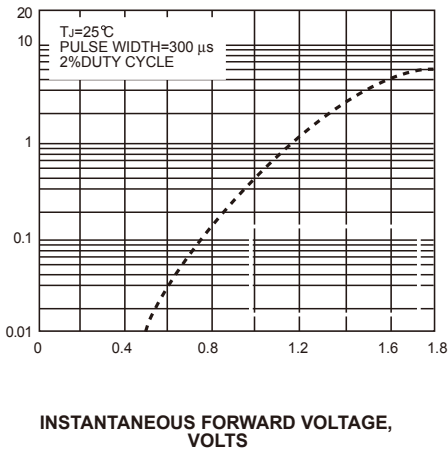
PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



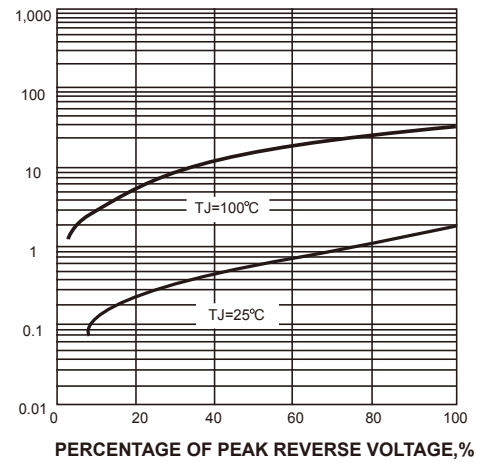
INSTANTANEOUS FORWARD CURRENT, AMPERES

FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



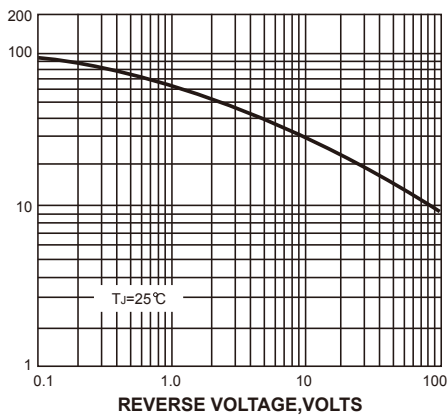
INSTANTANEOUS REVERSE CURRENT, MICROAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS



JUNCTION CAPACITANCE, pF

FIG. 5-TYPICAL JUNCTION CAPACITANCE



TRANSIENT THERMAL IMPEDANCE, °C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE

